STF43N60DM2

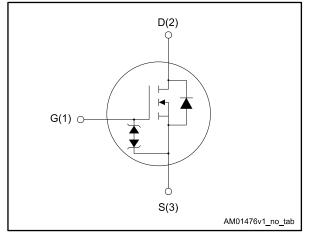
Datasheet - production data



N-channel 600 V, 0.085 Ω typ., 34 A MDmesh[™] DM2 Power MOSFET in a TO-220FP package

TO-220FP

Figure 1: Internal schematic diagram



Features

Order code	V _{DS} @ T _{jmax.}	R _{DS(on)} max.	ID	Ρτοτ
STF43N60DM2	650 V	0.093 Ω	34 A	40 W

- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

Applications

• Switching applications

Description

This high voltage N-channel Power MOSFET is part of the MDmeshTM DM2 fast recovery diode series. It offers very low recovery charge (Q_{rr}) and time (t_{rr}) combined with low $R_{DS(on)}$, rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

Table 1: Device summary

Order code	Marking	Package	Packing
STF43N60DM2	43N60DM2	TO-220FP	Tube

DocID026789 Rev 2

This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate-source voltage	±25	V
Ip ⁽¹⁾	Drain current (continuous) at T _{case} = 25 °C	34	А
ID	Drain current (continuous) at T _{case} = 100 °C	21	A
I _{DM} ⁽²⁾	Drain current (pulsed)	136	А
P _{TOT}	Total dissipation at T _{case} = 25 °C	40	W
dv/dt ⁽³⁾	Peak diode recovery voltage slope	50	V/ns
dv/dt ⁽⁴⁾	MOSFET dv/dt ruggedness	50	v/ns
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; $T_C = 25$ °C)	2500	V
T _{stg}	Storage temperature	55 to 150	°C
Tj	Operating junction temperature	-55 to 150	°C

Notes:

⁽¹⁾ limited by maximum junction temperature.

 $^{\left(2\right) }$ Pulse width is limited by safe operating area.

 $^{(3)}$ I_{SD} \leq 34 A, di/dt=900 A/µs; V_{DS} peak < V_{(BR)DSS}, V_{DD} = 400 V.

⁽⁴⁾ $V_{DS} \le 480 \text{ V}.$

Table 3: Thermal data

Symbol	Parameter	Value	Unit	
R _{thj-case}	Thermal resistance junction-case	0.32	°C 111	
R _{thj-amb}	Thermal resistance junction-ambient	62.5	°C/W	

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive	6	А
E _{AS} ⁽¹⁾	Single pulse avalanche energy	800	mJ

Notes:

 $^{(1)}$ starting T_{j} = 25 °C, I_{D} = $I_{AR},\,V_{DD}$ = 50 V.



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	600			V
	Zoro goto voltago droin	$V_{GS} = 0 V, V_{DS} = 600 V$			1	
I _{DSS} Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 600 V,$ $T_{case} = 125 \text{ °C}$			100	μA	
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			±5	μA
V _{GS(th)}	Gate threshold voltage	V_{DS} = V_{GS} , I_D = 250 μ A	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	V_{GS} = 10 V, I_{D} = 17 A		0.085	0.093	Ω

Table 6: Dynamic						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	2500	-	
Coss	Output capacitance	$V_{DS} = 100 V$, f = 1 MHz,	-	120	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	-	3	-	P'
C _{oss eq.} ⁽¹⁾	Equivalent output capacitance	V_{DS} = 0 to 480 V, V_{GS} = 0 V	-	200	-	pF
R _G	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	4	-	Ω
Qg	Total gate charge	V _{DD} = 480 V, I _D = 34 A,	-	56	-	
Q_gs	Gate-source charge	V_{GS} = 10 V (see <i>Figure 15:</i>	-	13	-	nC
Q_{gd}	Gate-drain charge	"Gate charge test circuit")	-	30	-	

Notes:

 $^{(1)}$ $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 25 \text{ A}$	-	29	-	
tr	Rise time	$R_G = 4.7 \Omega, V_{GS} = 10 V$ (see Figure 14: "Switching	-	27	-	
t _{d(off)}	Turn-off delay time	times test circuit for	-	85	-	ns
t _f	Fall time	resistive load" and Figure 19: "Switching time waveform")	-	6	-	



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD} ⁽¹⁾	Source-drain current		-		34	Α
I _{SDM} ⁽²⁾	Source-drain current (pulsed)		-		136	А
V _{SD} ⁽³⁾	Forward on voltage	$V_{GS} = 0 V, I_{SD} = 34 A$	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 34 A,	-	120		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/µs, V _{DD} = 60 V (see <i>Figure 16:</i>	-	0.6		μC
I _{RRM}	Reverse recovery current	"Test circuit for inductive load switching and diode recovery times")	-	10.4		A
t _{rr}	Reverse recovery time	I _{SD} = 34 A,	-	240		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/ μ s, V _{DD} = 60 V, T _j = 150 °C (see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	2.4		μC
	Reverse recovery current		-	20.5		A

 Table 8: Source-drain diode

Notes:

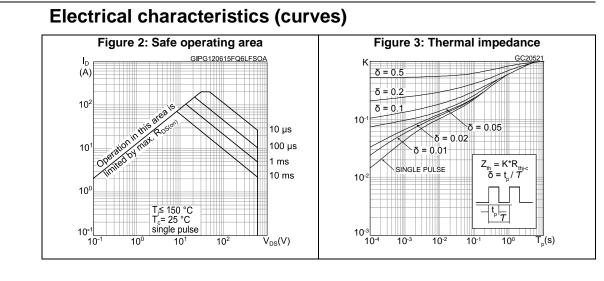
 $^{\left(1\right) }$ Limited by maximum junction temperature.

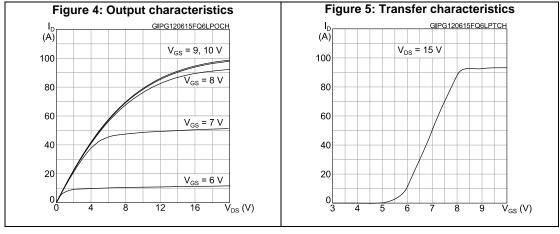
⁽²⁾ Pulse width is limited by safe operating area.

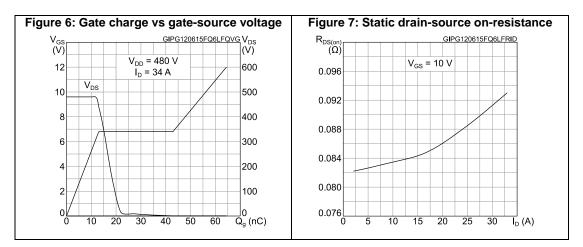
 $^{(3)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.



2.1

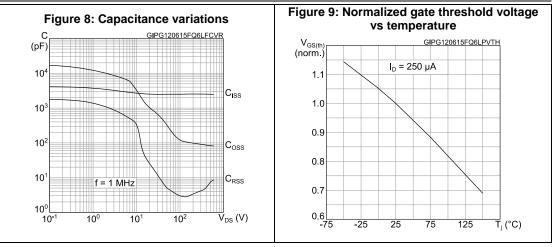


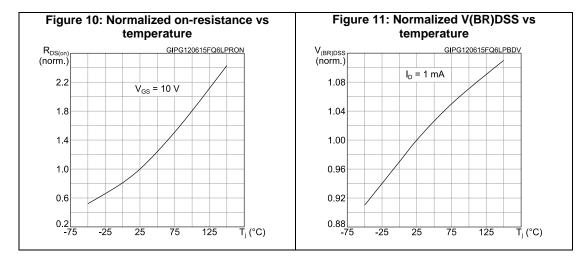


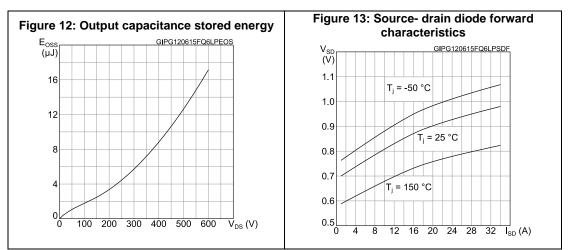




Electrical characteristics

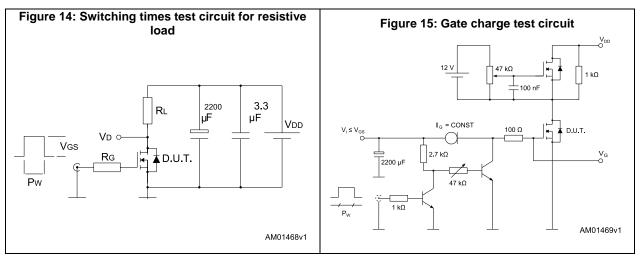


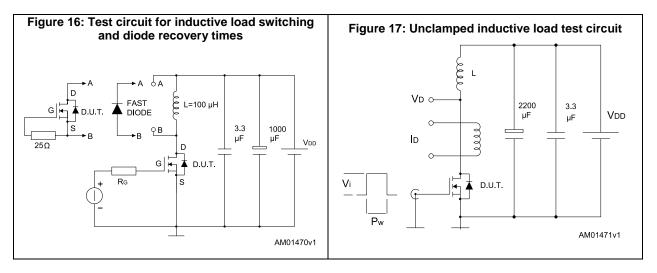


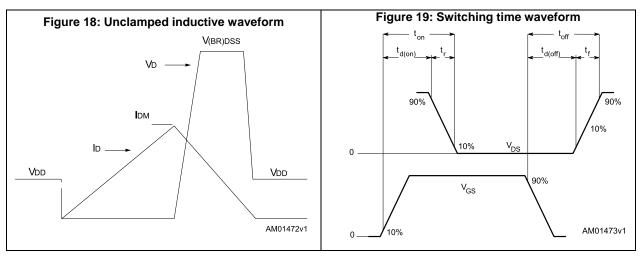




3 Test circuits







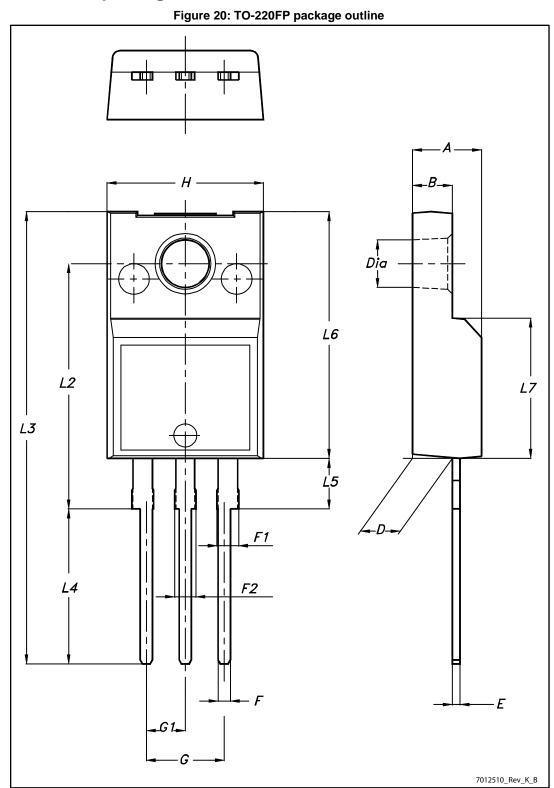
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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.









STF43N60DM2

Package information

Table 9: TO-220FP	package mechanical data
	package mechanical uala

Table 9: TO-220FP package mechanical data				
Dim.	mm			
	Min.	Тур.	Max.	
A	4.4		4.6	
В	2.5		2.7	
D	2.5		2.75	
E	0.45		0.7	
F	0.75		1	
F1	1.15		1.70	
F2	1.15		1.70	
G	4.95		5.2	
G1	2.4		2.7	
Н	10		10.4	
L2		16		
L3	28.6		30.6	
L4	9.8		10.6	
L5	2.9		3.6	
L6	15.9		16.4	
L7	9		9.3	
Dia	3		3.2	



5 Revision history

 Table 10: Document revision history

Date	Revision	Changes
06-Aug-2014	1	First release.
01-Jul-2015	2	Text and formatting changes throughout document Datasheet promoted from preliminary data to production data On cover page: - updated title description - updated features table In Section Electrical ratings: - updated Table Absolute maximum ratings - updated Table Avalanche characteristics In Section Electrical characteristics: - updated and renamed Table Static (was On/off states) - updated Table Dynamic - updated Table Switching times - updated Table Source-drain diode Added Section 2.1 Electrical characteristics (curves)



STF43N60DM2

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